



SUSS MICROTEC INVESTOR PRESENTATION

November 2012

DISCLAIMER

This presentation contains forward-looking statements relating to the business, financial performance and earnings of SUSS MicroTec AG and its subsidiaries and associates. Forward-looking statements are based on current plans, estimates, projections and expectations and are therefore subject to risks and uncertainties, most of which are difficult to estimate and which in general are beyond the control of SUSS MicroTec AG. Consequently, actual developments as well as actual earnings and performance may differ materially from those which explicitly or implicitly assumed in the forward-looking statements. SUSS MicroTec AG does not intend or accept any obligation to publish updates of these forward-looking statements.

- **SUSS MicroTec at a Glance**
- **Products and Markets**
- **Growth Opportunities**
- IV. Acquisition of Tamarack Scientific Co. Inc.
- V. Financials
- VI. Outlook



- + SUSS MicroTec: A global leader in semiconductor equipment
- Our equipment and process solutions create the micro structures that build and connect micro electronic devices
- + We are focused on high growth market segments: Semiconductors, MEMS, LEDs

- + Key Data:
 - Stock Exchange Symbol: SMHN
 - TecDAX
 - Share price*: 7.26 €
 - Market Cap*: 139 € million
 - Net Cash, September 2012: 30.7 € million



^{*} October 31, 2012

Germany



Garching

- SUSS MicroTec HQ
- Development/production:
 - Mask Aligner
 - Bond Aligner
- Core competencies:
 - Exposure (proximity exposure)
 - Alignment



Sternenfels

- Development/production :
 - Bonder
 - Coater and Developer
 - Photomask Equipment
- + Core competencies:
 - Wet processing
 - Wafer bonding

USA



Corona

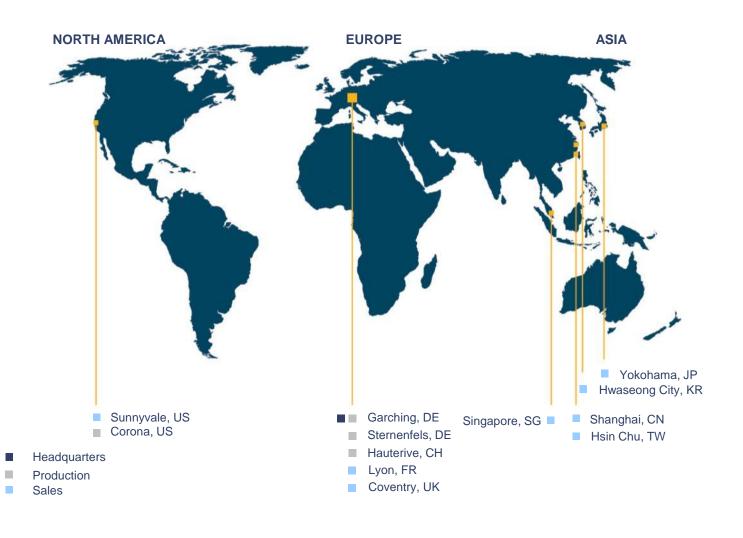
- + Development/production:
 - Stepper/Scanner
 - Laser Processing
- + Core competencies:
 - Exposure (UV projection lithography)
 - Laser Ablation

PRODUCTION SITE - UPDATE ON SUSS MICROOPTICS

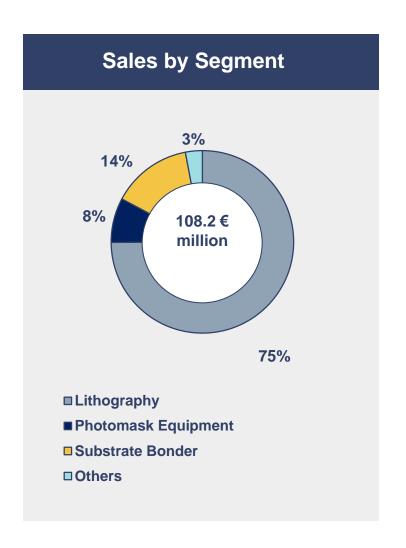
- + SUSS MicroOptics is a leading supplier for high-quality micro-optics (for instance the MO Exposure Optics, an innovative upgrade for SUSS mask aligners)
- + The technology leadership and innovation allowed a CAGR of 20% over last 10 years and is a solid base for continuous future growth
- In November 2012 SUSS MicroOptics moved into a new production facility:
 - Class 100/1000 cleanroom (415m² surface)
 - Total investment of more than 2 € million
 - Start of operation by the end of November
 - New cleanroom fab allows to move from one shift (8h/5d) to 24/7 operation



SUSS MICROTEC - A GLOBAL PLAYER



SALES BY SEGMENT AND REGION 9M 2012





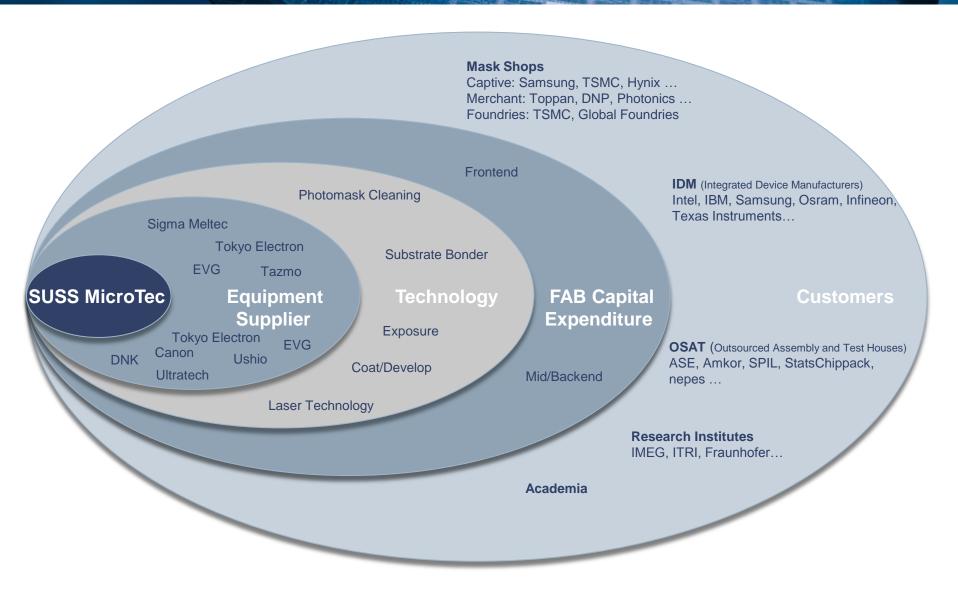
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SUSS MICROTEC IN THE VALUE CHAIN



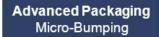
- Key player in providing state-of-the-art semiconductor manufacturing equipment
- Development of highly innovative process solutions with industry and R&D partners
- Components for electronic devices like cell phones, PCs and tablet computers are produced on SUSS MicroTec's equipment

THE SEMICONDUCTOR MARKET



Semiconductors

Mask Manufacturing Photomask Cleaning





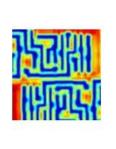
Sensors

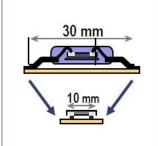
MEMS Computing, Automotive, Medical Applications ...

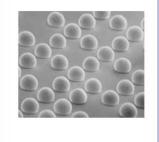
Lighting

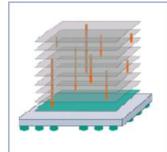
LED General Lighting, HB and UHB LED







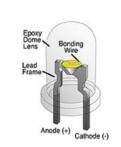














Segments	Photomask Equipment	Lithography			Substrate Bonder
Products	MaskTrack Pro	Expos	sure Systems	Coater/Developer	Wafer Bonder
	Frontend	Back	end :		
Process Steps	Photomask Cleaning	Stepper, Scanner (UV projection) Laser Ablation	Mask Aligner (proximity exposure) Nano Imprinting	Coating Developing	Bond Alignment Permanent Bonding Temporary Bonding
Key figures 9M 2012	Sales: 8.6 € million EBIT: -2.5 € million		Sales: 81.1 € million EBIT: 16.3 € million		Sales: 15.3 € million EBIT: -9.2 € million

SEGMENTS AND MARKETS

Segments	Photomask Equipment		Lithography		Substrate Bonder
Products	MaskTrack Pro	Exposi	ure Systems	Coater/Developer	Wafer Bonder
	Frontend	Back	end		
Process Steps	Photomask Cleaning	Stepper, Scanner (UV projection) Laser Ablation	Mask Aligner (proximity exposure) Nano Imprinting	Coating Developing	Bond Alignment Permanent Bonding Temporary Bonding
Markets	Mask Manufacturing	Advanced Packag	ina		
		3D Integration			
		MEMS			
	LED				

SEGMENTS AND PRODUCTION SITES

Segments	Photomask Equipment	Lithography			Substrate Bonder	
Products	MaskTrack Pro	Exposure Systems		Coater/Developer	Wafer Bonder	
	Frontend	Backend				
Process Steps	Photomask Cleaning	Stepper, Scanner (UV projection) Laser Ablation	Mask Aligner (proximity exposure) Nano Imprinting	Coating Developing	Bond Alignment Permanent Bonding Temporary Bonding	
Production Sites	Sternenfels	Corona	Garching	Sternenfels		

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MEGA TRENDS DRIVING THE INDUSTRY

- + Global mega-trends drive the microelectronics industry and create long term opportunities
 - **Digital Lifestyle**
 - **E-Mobility**
 - **Energy efficiency**
- + Micro chips, MEMS und LEDs are the building blocks for the technological product advancement
- + SUSS MicroTec's focus is to offer development and manufacturing solutions for these components in markets that have a sustainable long term growth perspective



Digital lifestyle

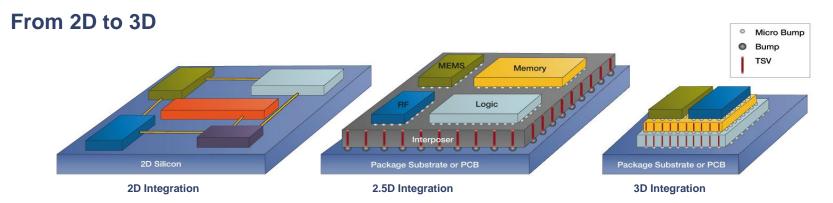


E-mobility



Energy efficiency

SCALING TECHNOLOGIES



- + Technical challenges and limitations make it increasingly more difficult and expensive to reduce the feature size of integrated circuits (shrinking)
- + Complementary technologies like Wafer Level Packaging (WLP) and 3 Dimensional Chip Stacking (3DIC) circumvent the deficiencies of traditional scaling and allow increasing density and functionality at lower cost
- + This extension beyond the conventional shrink roadmap is called "More than Moore"
 - Packaging becomes the key enabler for scaling
 - Manufacturing value is shifting from silicon to the package
 - SUSS MicroTec is one of the few companies offering a comprehensive equipment and process solution spectrum for WLP and 3DIC

EXPECTED MARKET DEVELOPMENTS

- + SUSS MicroTec's portfolio of equipment addresses fast growing target markets:
 - 3D Integration / Advanced Packaging, LED and MEMS
- + With its strong market position SUSS MicroTec will benefit from the expected market developments:
 - Advanced Packaging (wafer level packaging and flip chip) remains more robust than the overall market, primarily driven by advanced applications for smart phones and tablets
 - TSV processes expected to transition to production volume in the years to come
 - Compound Semi (LED, MEMS, RF, Optoelectronics, III-V Power) are expected to remain robust based on smartphone and tablet growth and will drive further demand for advanced packaging solutions

Segment growth 2011 - 2016E CAGR ~ 15% (Gartner and industry estimates)

ENABLING SEMICONDUCTOR TRENDS

- + The further increase in complexity and performance of future semiconductor device generations demands the continuous progress in scaling of these devices
- + SUSS MicroTec's equipment and process solutions enable the 2-dimensional reduction of feature sizes ("Moore's Law") as well as the 3-dimensional stacking of integrated circuits ("More than Moore")



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TAMARACK SCIENTIFIC AT A GLANCE

- Tamarack Scientific develops and builds UV projection lithography systems and laser micro-structuring tools
- Tamarack targets the same high growth market segments as SUSS MicroTec: Advanced Packaging, 3D Integration, MEMS and LED

Key Data:

- Founded 1966, based in Corona, California
- Installed base larger than 1,100 systems
- Revenues FY11/12: app. 10 million €
- 63 employees
- Total purchase price 9.34 million \$ (plus additional variable earn-out component)



STRATEGIC REASONS FOR THE ACQUISITION OF TAMARACK

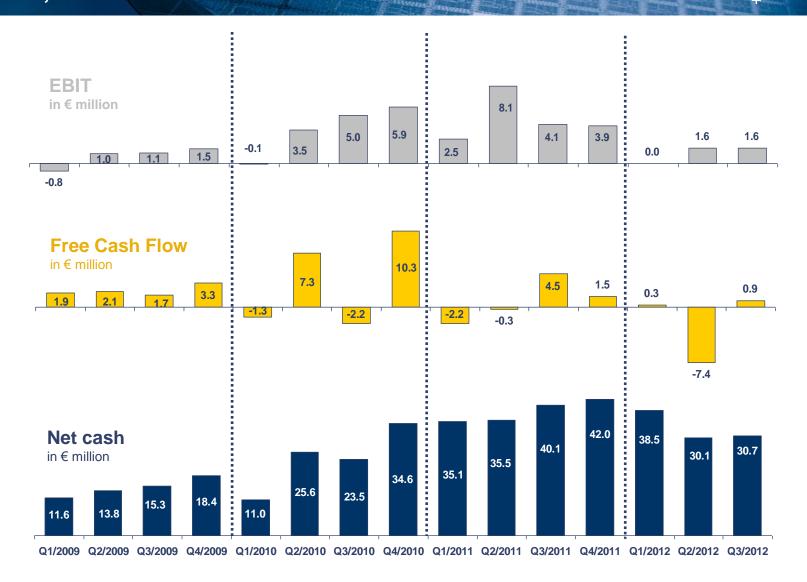
- Increasing chip performance requires adoption of innovative lithography technologies in the semiconductor backend
- Not one technology fits all needs
- Add new and highly complementary product line with the core technologies UV projection lithography and laser micro-structuring
- SUSS MicroTec's global sales and support structure plus Tamarack's technology offering enable the expansion of SUSS MicroTec's lithography footprint
- SUSS MicroTec as a financially strong and globally positioned company can unlock the potential of Tamarack and enable high future growth



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EBIT, FREE CASH FLOW AND NET CASH DEVELOPMENT



KEY FINANCIALS

in € million	Q3 2012	Q3 2011	in %
THE THIMBOTT	Q3 2012	Q3 2011	111 70
Order Intake	36.6	38.2	-4.2%
Order Backlog (09/30)			_
Revenue	40.7	45.9	-11.3%
EBIT	1.6	4.1	-61.0%
	110	7.1	01.070
EBIT in % of Sales	3.9%	8.9%	
Earnings after tax (cont. operations)	0.4	2.9	-86.2%
Earnings after tax	0.4	2.9	-86.2%
EPS in € (basic)	0.02	0.15	-86.7%
()			
Free Cash Flow*	0.9	4.5	-80.0%
Net Cash**			
Employees (09/30)	_		

	ı	
9M 2012	9M 2011	in %
117.0	118.6	-1.3%
102.4	103.5	-1.1%
102.4	103.5	-1.170
108.2	130.6	-17.2%
3.1	14.7	-78.9%
2.9%	11.3%	
	7.1.070	
0.8	11.2	-92.9%
2.3	11.2	-79.5%
0.12	0.59	-79.7%
-6.2	2.0	<-100%
30.7	40.1	-23.4%
699	637	+9.7%

 $^{^{\}star}$ before consideration of purchased interest-bearing securities $\,$ and M&A activities $\,^{\star\star}$ incl. stock of interest-bearing securities

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GUIDANCE AND INVESTMENT CASE

Guidance

+ FY 2012:

- Sales between 160 and 170 € million
- FBIT between 5 and 10 € million

- + Q4 2012:
- Order Intake 25 40 € million

Investment Case

- + Strong fundamental growth in target markets
- + Strong competitive positioning: first or second in the target markets
- + Leading equipment company in the semiconductor backend, enabling "Moore's Law" as well as "More than Moore"
- + Significant mid term revenue opportunity
- + Play active role in the consolidation of the backend



Thank you

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INVESTOR RELATIONS INFORMATION

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Financial Calendar 2012/13

Financial Calendar 2012

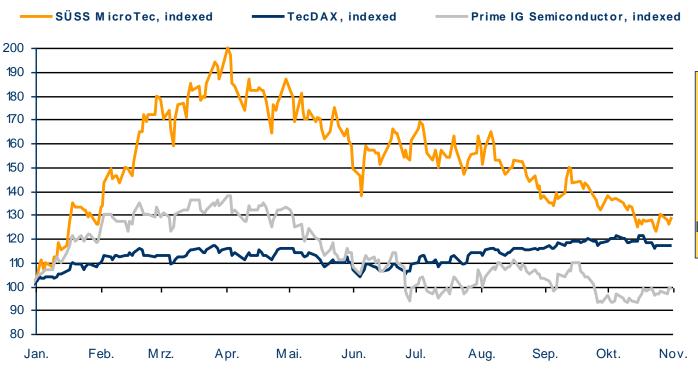
German Equity Forum, Frankfurt/Main	November 12 - 14
TMT Konferenz Morgan Stanley, Barcelona	November 16

Financial Calendar 2013

Cheuvreux German Corporate Conference, Frankfurt/Main	January 21
Annual Report 2012	March 28
Quarterly Report 2013	May 8
Commerzbank German Midcap Conference, Boston/New York	May 22/23
Shareholders' Meeting, Haus der Bayerischen Wirtschaft, Munich	June 19
Interim Report 2013	August 8
Nine-month Report 2013	November 7

SUSS MICROTEC SHARE PRICE DEVELOPMENT

(Price of the SUSS MicroTec Share at December 30, 2011, € 5.63)



Major Shareholders:

DWS Germany 8.68%

Credit Suisse Switzerland 3.35%

BlackRock 3,23%

Henderson Global Invest, 3,14%

DWS Luxembourg 3.04%

Average daily trading volume 2012: 123,000